

HOSTAFORM® C 9021 TF XAP®2

Tribological; low Emission

Chemical abbreviation according to ISO 1043-1: POM Molding compound ISO 29988- POM-K, M-GNS, 2-2 POM copolymer Injection molding type, modified with PTFE; good chemical resistance to solvents, fuel and strong alkalis as well as good hydrolysis resistance; high resistance to thermal and oxidative degradation; for sliding combinations with very low coefficient of friction. Reduced emission grade. Emissions according to VDA 275 < 5 mg/kg Burning rate ISO 3795 and FMVSS 302 < 100 mm/min for a thickness more than 1 mm. Ranges of applications: For sliding combinations with very low coefficient of friction. FMVSS = Federal Motor Vehicle Safety Standard (USA)

Product information

Part Marking Code	POM	ISO 11469
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Rheological properties

Melt volume-flow rate	6 cm ³ /10min	ISO 1133
Temperature	190 °C	
Load	2.16 kg	
Moulding shrinkage range, parallel	2.0 %	ISO 294-4, 2577
Moulding shrinkage range, normal	1.7 %	ISO 294-4, 2577

Typical mechanical properties

Tensile Modulus	2350 MPa	ISO 527-1/-2
Yield stress, 50mm/min	50 MPa	ISO 527-1/-2
Yield strain, 50mm/min	10 %	ISO 527-1/-2
Nominal strain at break	16 %	ISO 527-1/-2
Flexural Modulus	2250 MPa	ISO 178
Tensile creep modulus, 1h	2000 MPa	ISO 899-1
Tensile creep modulus, 1000h	1150 MPa	ISO 899-1
Charpy impact strength, 23°C	60 kJ/m ²	ISO 179/1eU
Charpy impact strength, -30°C	60 kJ/m ²	ISO 179/1eU
Charpy notched impact strength, 23°C	4 kJ/m ²	ISO 179/1eA
Charpy notched impact strength, -30°C	4 kJ/m ²	ISO 179/1eA
Ball indentation hardness, H 358/30	120 MPa	ISO 2039-1

Thermal properties

Melting temperature, 10°C/min	166 °C	ISO 11357-1/-3
Temp. of deflection under load, 1.8 MPa	98 °C	ISO 75-1/-2
Vicat softening temperature, 50°C/h, 50N	145 °C	ISO 306
Coeff. of linear therm. expansion, parallel	110 E-6/K	ISO 11359-1/-2

Electrical properties

Relative permittivity, 100Hz	3.7	IEC 62631-2-1
Relative permittivity, 1MHz	3.7	IEC 62631-2-1
Dissipation factor, 100Hz	20 E-4	IEC 62631-2-1
Dissipation factor, 1MHz	80 E-4	IEC 62631-2-1

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Volume resistivity	1E12 Ohm.m	IEC 62631-3-1
Surface resistivity	1E14 Ohm	IEC 62631-3-2
Electric strength	33 kV/mm	IEC 60243-1
Comparative tracking index	PLC 0 PLC	UL 746A

Other properties

Humidity absorption, 2mm	0.2 %	Sim. to ISO 62
Water absorption, 2mm	0.65 %	Sim. to ISO 62
Density	1510 kg/m³	ISO 1183

Injection

Drying Temperature	100 - 120 °C
Drying Time, Dehumidified Dryer	3 - 4 h
Processing Moisture Content	0.15 %
Screw tangential speed	0.2 - 0.21 m/s
Max. mould temperature	80 - 120 °C
Back pressure	2 MPa
Injection speed	slow

Characteristics

Additives	Release agent
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Processing Texts

Pre-drying	It is normally not necessary to dry HOSTAFORM. However, should there be surface moisture (condensate) on the molding compound as a result of incorrect storage, drying is required. A circulating air drying cabinet can be used for this purpose.
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Longer pre-drying times/storage	The product can then be stored in standard conditions until processed.
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Other Approvals

Other Approvals	OEM	Specification	Additional Information
	Mercedes-Benz Group (Daimler)	DBL 5404	BQF
	Mercedes-Benz Group (Daimler)	DBL 5410	

